LCD EMI Filter Array with ESD Protection

Features

- Eight channels of EMI filtering
- ±30kV ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- ±30kV ESD protection on each channel (HBM)
- Better than 35dB of attenuation at 800-2700MHz
- Chip Scale Package features extremely low lead inductance for optimum filter and ESD performance
- 20-bump, 4.000mm x 1.458mm footprint Chip Scale Package
- *OptiGuard*[™] coated version available for improved reliability at assembly
- Lead-free version available

Applications

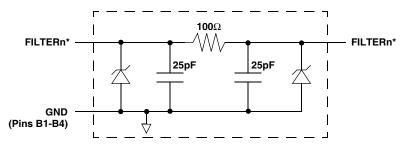
- LCD data lines in mobile handsets
- EMI filtering & ESD protection for high-speed I/O ports
- EMI filtering for high-speed data lines
- Wireless handsets
- Cell phones
- Notebook computers
- PDAs / Handheld PCs

Product Description

California Micro Device's CM1405 is an EMI filter array with ESD protection, which integrates eight Pi- filters (C-R-C). The CM1405 has component values of 25pF-100 Ω -25pF. The parts include avalanche-type ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports safely dissipate ESD strikes of ±30kV, exceeding the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30kV.

This device is particularly well-suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy-to-use pin assignments. In particular, the CM1405 is ideal for EMI filtering and protecting data lines from ESD for the LCD display in mobile handsets.

The CM1405-03 incorporates *OptiGuard*[™] coating which results in improved reliability at assembly and is available in space-saving, low-profile chip-scale packages with optional lead-free finishing.



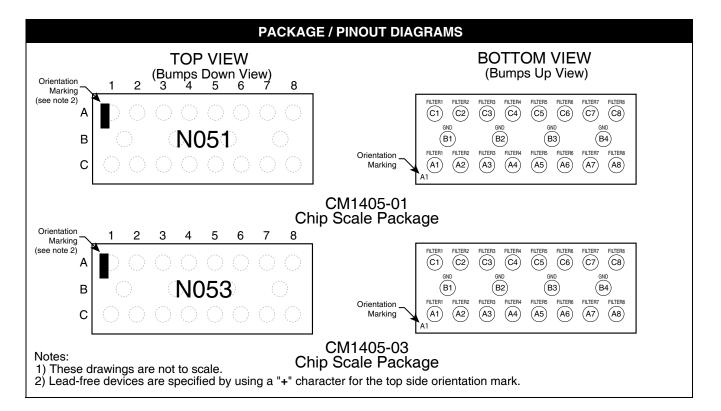
1 of 8 EMI Filtering + ESD Channels

* See Package/Pinout Diagram for expanded pin information.

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Electrical Schematic



PIN DESCRIPTIONS									
PIN(s)	NAME	DESCRIPTION	PIN(s)	NAME	DESCRIPTION				
A1	FILTER1	Filter Channel 1	C1	FILTER1	Filter Channel 1				
A2	FILTER2	Filter Channel 2	C2	FILTER2	Filter Channel 2				
A3	FILTER3	Filter Channel 3	C3	FILTER3	Filter Channel 3				
A4	FILTER4	Filter Channel 4	C4	FILTER4	Filter Channel 4				
A5	FILTER5	Filter Channel 5	C5	FILTER5	Filter Channel 5				
A6	FILTER6	Filter Channel 6	C6	FILTER6	Filter Channel 6				
A7	FILTER7	Filter Channel 7	C7	FILTER7	Filter Channel 7				
A8	FILTER8	Filter Channel 8	C8	FILTER8	Filter Channel 8				
B1-B4	GND	Device Ground							

Ordering Information

PART NUMBERING INFORMATION									
	Standard Finish Lead-free Finish ²								
		No Coati	ing	Optiguard [™]	Coated	No Coating		Optiguard TM Coated	
Bumps	PKG	Ordering Part Number ¹	Part Marking						
20	CSP	CM1405-01CS	N051	CM1405-03CS	N053	CM1405-01CP	N051	CM1405-03CP	N053

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

Note 2: Lead-free devices are specified by using a "+" character for the top side orientation mark.

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Specifications

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	RATING	UNITS						
Storage Temperature Range	-65 to +150	°C						
DC Power per Resistor	100	mW						
DC Package Power Rating	500	mW						

STANDARD OPERATING CONDITIONS							
PARAMETER	RATING	UNITS					
Operating Temperature Range	-40 to +85	°C					

	ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1)									
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS				
R	Resistance		80	100	120	Ω				
С	Capacitance	At 2.5V DC, 1MHz, 30mV AC	20	25	30	pF				
V _{DIODE}	Diode Standoff Voltage	I _{DIODE} = 10μA		6.0		V				
I _{LEAK}	Diode Leakage Current (reverse bias)	V _{DIODE} = +3.3V		0.1	1	μA				
V _{SIG}	Signal Voltage Positive Clamp Negative Clamp	I _{LOAD} = 10mA I _{LOAD} = -10mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	v v				
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	Notes 2 and 3	±30 ±30			kV kV				
R _{DYN}	Dynamic Resistance Positive Negative			1.5 0.9		Ω Ω				
f _c	Cut-off Frequency Z_{SOURCE} =50 Ω , Z_{LOAD} =50 Ω	R = 100Ω, C = 25pF		70		MHz				

Note 1: $T_A = 25^{\circ}C$ unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: These parameters are guaranteed by design and characterization.

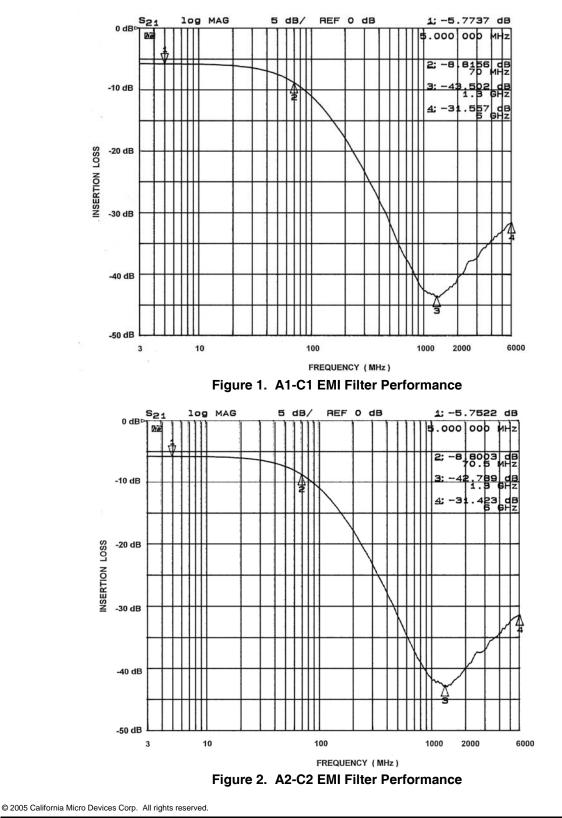
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Performance Information

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ohm Environment)

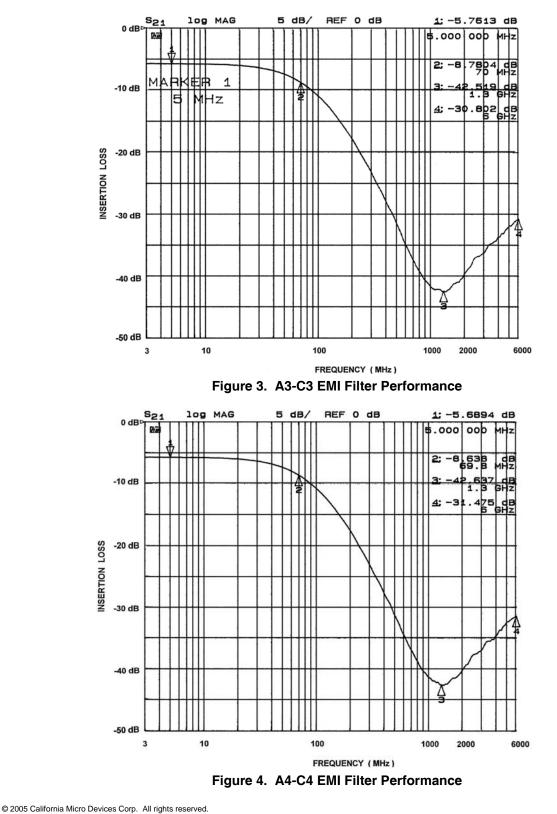


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Performance Information (cont'd)

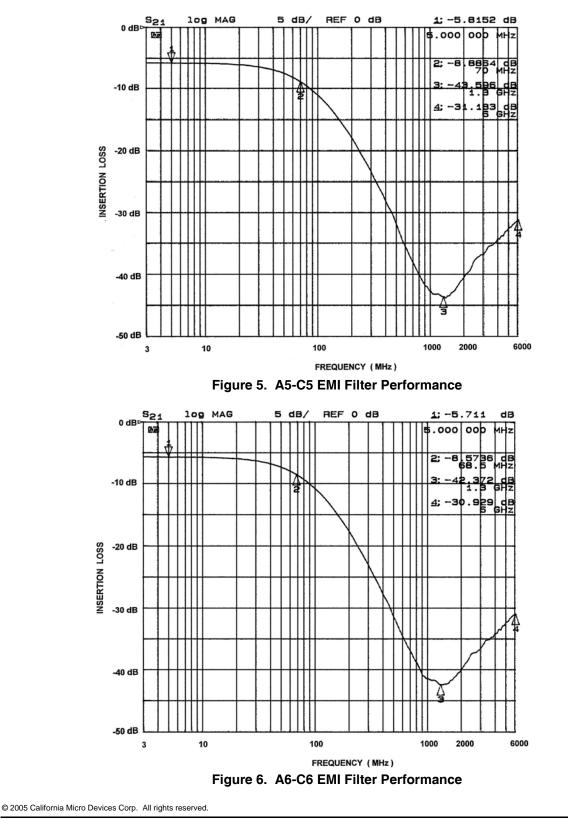
Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ohm Environment)



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Performance Information (cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ohm Environment)

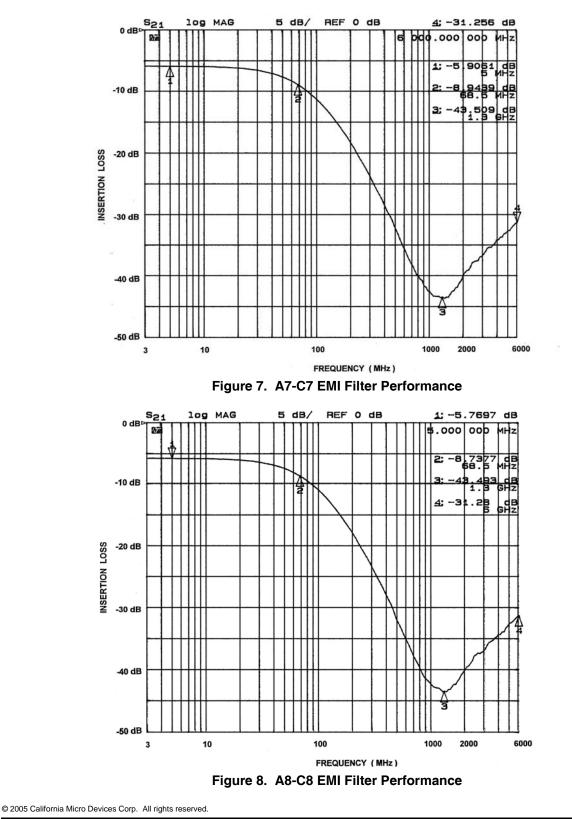


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Performance Information (cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ohm Environment)



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Performance Information (cont'd)

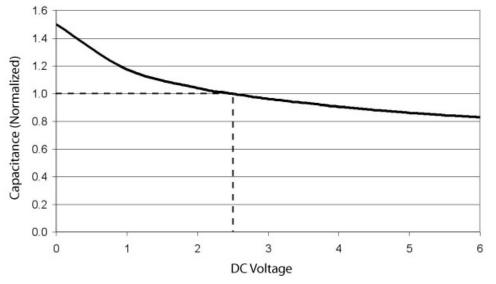


Figure 9. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5VDC and 25°C)

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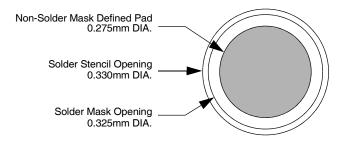
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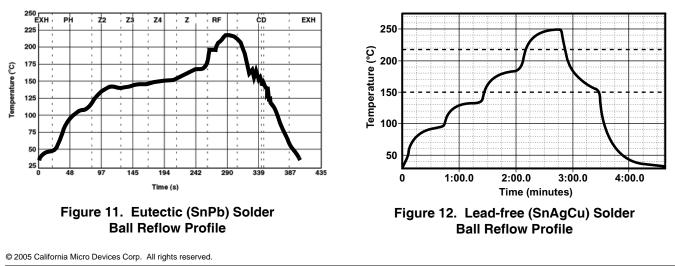
Application Information

Refer to Application Note AP-217, "The Chip Scale Package", for a detailed description of Chip Scale Packages offered by California Micro Devices.

PRINTED CIRCUIT BOARD RECOMMENDATIONS						
PARAMETER	VALUE					
Pad Size on PCB	0.275mm					
Pad Shape	Round					
Pad Definition	Non-Solder Mask defined pads					
Solder Mask Opening	0.325mm Round					
Solder Stencil Thickness	0.125mm - 0.150mm					
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.330mm Round					
Solder Flux Ratio	50/50 by volume					
Solder Paste Type	No Clean					
Pad Protective Finish	OSP (Entek Cu Plus 106A)					
Tolerance — Edge To Corner Ball	<u>+</u> 50μm					
Solder Ball Side Coplanarity	<u>+</u> 20μm					
Maximum Dwell Time Above Liquidous (183°C)	60 seconds					
Maximum Soldering Temperature for a Eutectic Device using Eutectic Solder Paste	240°C					
Maximum Soldering Temperature for a Lead-free Device using Lead-free Solder Paste	260°C					







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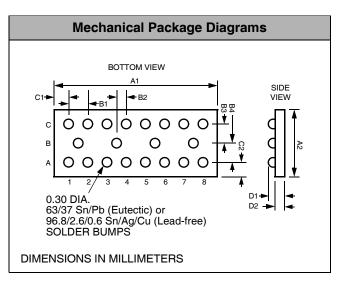
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Mechanical Details

CM1405-01 Mechanical Specifications

The package dimensions for the CM1405-01 are presented below.

PACKAGE DIMENSIONS							
Package Custom CSP							
Burr	nps			20			
Dim	Μ	lillimete	rs		Inches		
Diili	Min	Nom	Max	Min	Nom	Max	
A1	3.955	4.000	4.045	0.1557	0.1575	0.1593	
A2	1.413	1.458	1.503	0.0556	0.0574	0.0592	
B1	0.495	0.500	0.505	0.0195	0.0197	0.0199	
B2	0.245	0.250	0.255	0.0096	0.0098	0.0100	
B3	0.430	0.435	0.440	0.0169	0.0171	0.0173	
B4	0.430	0.435	0.440	0.0169	0.0171	0.0173	
C1	0.200	0.250	0.300	0.0079	0.0098	0.0118	
C2	0.244	0.294	0.344	0.0096	0.0116	0.0135	
D1	0.562	0.606	0.650	0.0221	0.0239	0.0256	
D2	0.356	0.381	0.406	0.0140	0.0150	0.0160	
	# per tape and 3500 pieces reel						
	Con	trolling o	dimensio	on: millim	eters		



Package Dimensions for CM1405-01 Chip Scale Package

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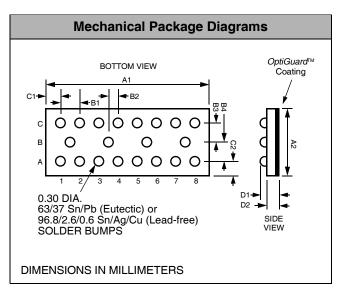
Mechanical Details (cont'd)

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CM1405-03 Mechanical Specifications

The package dimensions for the CM1405-03 are presented below.

PACKAGE DIMENSIONS									
Pack	age		Custom CSP						
Bum	nps			20					
Dim	Μ	lillimete	ers		Inches				
Dim	Min	Nom	Max	Min	Nom	Max			
A1	3.955	4.000	4.045	0.1557	0.1575	0.1593			
A2	1.413	1.458	1.503	0.0556	0.0574	0.0592			
B1	0.495	0.500	0.505	0.0195	0.0197	0.0199			
B2	0.245	0.250	0.255	0.0096	0.0098	0.0100			
B3	0.430	0.435	0.440	0.0169	0.0171	0.0173			
B4	0.430	0.435	0.440	0.0169	0.0171	0.0173			
C1	0.200	0.250	0.300	0.0079	0.0098	0.0118			
C2	0.244	0.294	0.344	0.0096	0.0116	0.0135			
D1	0.575	0.644	0.714	0.0226	0.0254	0.0281			
D2	0.368	0.419	0.470	0.0145	0.0165	0.0185			
	# per tape and 3500 pieces reel								
	Con	trolling o	dimensio	on: millim	eters				



Package Dimensions for CM1405-03 Chip Scale Package

CSP Tape and Reel Specifications

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B ₀ X A ₀ X K ₀	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P ₀	P ₁
CM1405-01	4.00 X 1.46 X 0.606	4.11 X 1.57 X 0.76	12mm	330mm (13")	3500	4mm	4mm
CM1405-03	4.00 X 1.46 X 0.644	4.11 X 1.57 X 0.76	12mm	330mm (13")	3500	4mm	4mm

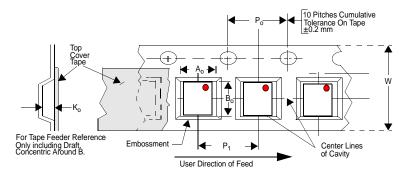


Figure 13. Tape and Reel Mechanical Data

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